

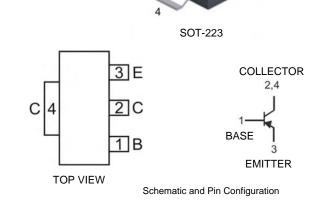


PNP SURFACE MOUNT TRANSISTOR

3

Features

- Epitaxial Planar Die Construction
- Complementary NPN Type Available (DZT853)
- Ideally Suited for Automated Assembly Processes
- Ideal for Medium Power Switching or Amplification Applications
- Lead Free By Design/RoHS Compliant (Note 1)
- "Green" Device (Note 2)
- **Mechanical Data**
- Case: SOT-223
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Finish Matte Tin annealed over Copper Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Marking & Type Code Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.115 grams (approximate)



Maximum Ratings $@T_A = 25^{\circ}C$ unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	-140	V
Collector-Emitter Voltage	V _{CEO}	-100	V
Emitter-Base Voltage	V _{EBO}	-6	V
Continuous Collector Current	Ι _C	-5	A
Power Dissipation	P _{tot}	1(Note 3) 3(Note 4)	W
Operating and Storage Temperature Range	Tj, T _{STG}	-55 to +150	°C

Notes: 1. No purposefully added lead.

2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.

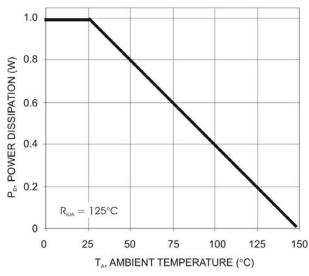
- 3. Device mounted on FR-4 PCB, pad layout as shown on page 4.
- 4. The power which can be dissipated, assuming the device is mounted in a typical manner on a PCB with copper equal to 4 square inch minimum.



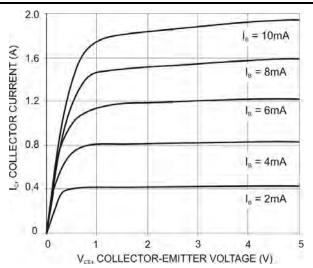
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS							
Collector-Base Breakdown Voltage	V _{(BR)CBO}	-140		_	V	$I_{\rm C} = -100 \mu A, I_{\rm E} = 0$	
Collector-Emitter Breakdown Voltage	V _{(BR)CEO}	-100	_	_	V	$I_{\rm C} = -10 {\rm mA}^*, I_{\rm B} = 0$	
Emitter-Base Breakdown Voltage	V _{(BR)EBO}	-6	_	_	V	$I_{E} = -100 \mu A, I_{C} = 0$	
Collector Cutoff Current		— — -50 -1			nA μA	$V_{CB} = -100V, I_E = 0$ $V_{CB} = -100V, I_E = 0, T_A = 100^{\circ}C$	
Emitter Cutoff Current	I _{EBO}	_	_	-10	nA	$V_{EB} = -6V, I_{C} = 0$	
ON CHARACTERISTICS							
Collector-Emitter Saturation Voltage	V _{CE(SAT)}		-20 -90 -160 -300	-50 -115 -220 -420	mV	$\begin{split} I_{C} &= -100 \text{mA}, \ I_{B} &= -10 \text{mA}^{*} \\ I_{C} &= -1\text{A}, \ I_{B} &= -100 \text{mA}^{*} \\ I_{C} &= -2\text{A}, \ I_{B} &= -200 \text{mA}^{*} \\ I_{C} &= -4\text{A}, \ I_{B} &= -400 \text{mA}^{*} \end{split}$	
Base-Emitter Saturation Voltage	V _{BE(SAT)}	_	-1010	-1170	mV	$I_{\rm C} = -4A, I_{\rm B} = -400 \text{mA}^*$	
Base-Emitter Turn-On Voltage	V _{BE(ON)}	_	-925	-1160	mV	$I_{CE} = -4A, V_{CE} = -1V^*$	
DC Current Gain	h _{FE}	100 100 50 30	— — — 15	 300 	_	$ \begin{split} & I_C = -10 mA, \ V_{CE} = -1 V^* \\ & I_C = -1A, \ V_{CE} = -1 V^* \\ & I_C = -3A, \ V_{CE} = -1 V^* \\ & I_C = -4A, \ V_{CE} = -1 V^* \\ & I_C = -10A, \ V_{CE} = -1 V^* \end{split} $	
SMALL SIGNAL CHARACTERISTICS							
Current Gain-Bandwidth Product	f⊤	_	125	_	MHz	$I_{C} = -100 \text{mA}, V_{CE} = -10 \text{V},$ f = 50MHz	
Output Capacitance	C _{obo}		65	—	pF	$V_{CB} = -10V$, f = 1MHz	
SWITCHING CHARACTERISTICS					·		
Switching Times	t _{on} t _{off}	_	110 460	_	ns	$I_{C} = -2A, I_{B1} = -200mA$ $I_{B2} = 200mA, V_{CC} = -10V$	

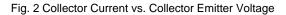
*Measured under pulsed conditions. Pulse width = 300 μs . Duty cycle ${\leq}2\%$

Typical Characteristics $@T_{amb} = 25^{\circ}C$ unless otherwise specified





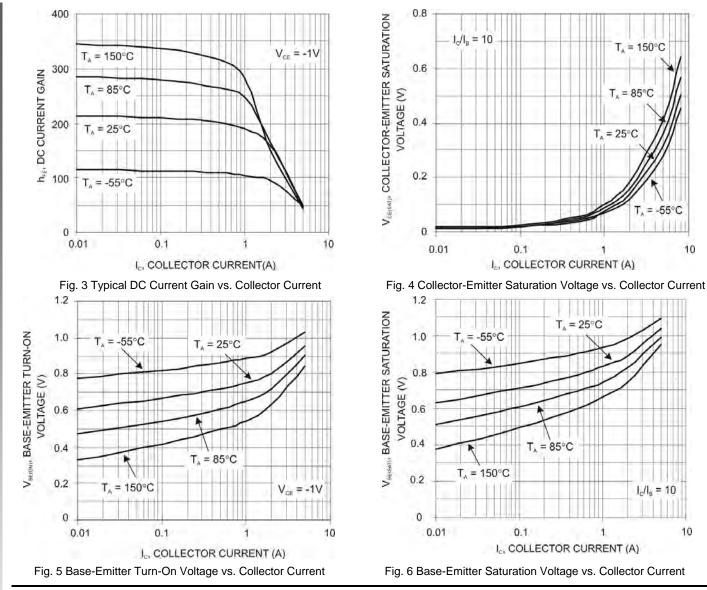




Notes: 3. Device mounted on FR-4 PCB, pad layout as shown on page 4.



NEW PRODUCT

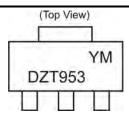


Ordering Information (Note 5)

Device	Valid Marking Codes	Packaging	Shipping
DZT953-13	DZT953	SOT-223	2500/Tape & Reel
DZT953-13	PT06	SOT-223	2500/Tape & Reel

Notes: 5. Packaging Details as shown on page 4, or go to our website at http://www.diodes.com/ap2007.pdf.

Marking Information



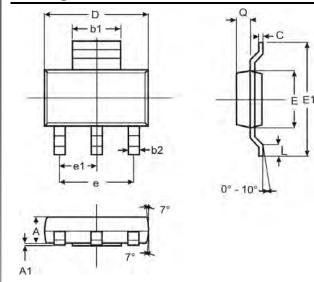
DZT953 or PT06= Product Type Marking Code YM = Date Code Marking Y = Year ex: T = 2006

M = Month ex: 9 = September

Date Code Key												
Year	200	6	2007		2008	20	09	2010		2011	1	2012
Code	Т		U		V	V	V	Х		Y		Z
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

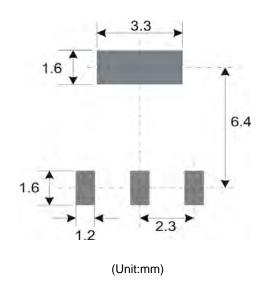


Package Outline Dimensions



SOT-223							
Dim	Min	Тур					
Α	1.55	1.65	1.60				
A1	0.010	0.15	0.05				
b1	2.90	3.10	3.00				
b2	0.60	0.80	0.70				
С	0.20	0.30	0.25				
D	6.45	6.55	6.50				
Е	3.45	3.55	3.50				
E1	6.90	7.10	7.00				
e	_	l	4.60				
e1	_	_	2.30				
L	0.85	1.05	0.95				
q	0.84	0.94	0.89				
All C	All Dimensions in mm						

Suggested Pad Layout: (Based on IPC-SM-782)



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